

# swissbit®

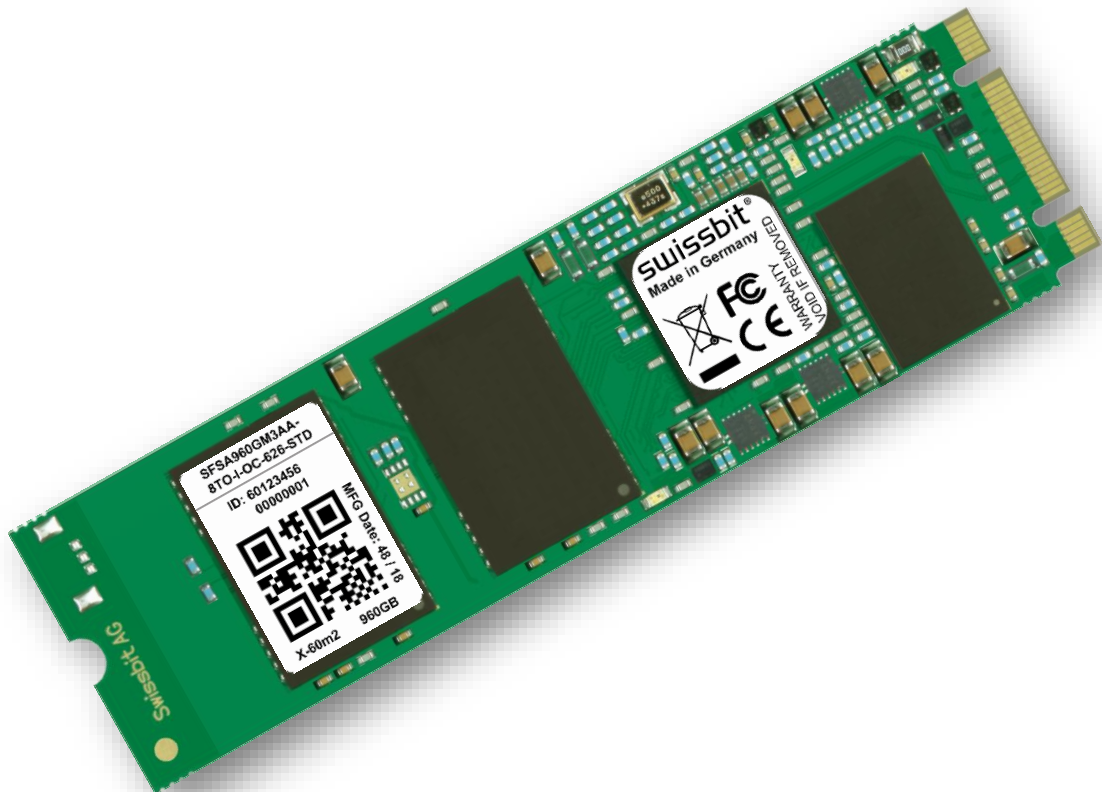
Product Data Sheet

## Industrial M.2 SATA SSD

### X-60m2 Series

SATA III - 6.0 Gbit/s

Standard and Industrial  
Temperature Grade



# Contents

<b>1. PRODUCT SUMMARY</b> .....	<b>3</b>
<b>2. PRODUCT FEATURES</b> .....	<b>4</b>
<b>3. ORDERING INFORMATION</b> .....	<b>5</b>
<b>4. PRODUCT DESCRIPTION</b> .....	<b>7</b>
4.1 PERFORMANCE SPECIFICATIONS .....	8
4.2 CURRENT CONSUMPTION .....	8
4.3 ENVIRONMENTAL SPECIFICATIONS .....	9
4.4 REGULATORY COMPLIANCE .....	10
4.5 MECHANICAL SPECIFICATIONS .....	10
4.6 RELIABILITY AND ENDURANCE .....	11
4.7 DRIVE GEOMETRY SPECIFICATION .....	11
<b>5. ELECTRICAL INTERFACE</b> .....	<b>12</b>
<b>6. PACKAGE MECHANICAL</b> .....	<b>13</b>
<b>7. ATA COMMANDS</b> .....	<b>14</b>
<b>8. IDENTIFY DEVICE INFORMATION</b> .....	<b>16</b>
<b>9. S.M.A.R.T. FUNCTIONALITY</b> .....	<b>17</b>
9.1 S.M.A.R.T. SUBCOMMANDS .....	17
9.2 S.M.A.R.T. READ DATA .....	18
9.3 S.M.A.R.T. ATTRIBUTES .....	18
9.4 S.M.A.R.T. ATTRIBUTE ENTRY STRUCTURE .....	19
<b>10. PART NUMBER DECODER</b> .....	<b>20</b>
10.1 MANUFACTURER .....	20
10.2 MEMORY TYPE .....	20
10.3 PRODUCT TYPE .....	20
10.4 DENSITY .....	20
10.5 PLATFORM .....	20
10.6 PRODUCT GENERATION .....	20
10.7 MEMORY ORGANIZATION .....	20
10.8 TECHNOLOGY .....	20
10.9 NUMBER OF FLASH CHIPS .....	20
10.10 FLASH CODE .....	21
10.11 TEMPERATURE OPTION .....	21
10.12 DIE CLASSIFICATION .....	21
10.13 PIN MODE .....	21
10.14 DRIVE CONFIGURATION XYZ .....	21
10.15 OPTION .....	21
<b>11. SWISSBIT M.2 SSD MARKING SPECIFICATION</b> .....	<b>22</b>
11.1 TOP VIEW .....	22
11.2 LABEL CONTENT .....	22
<b>12. REVISION HISTORY</b> .....	<b>23</b>

# X-60m2 Series – Industrial M.2 Solid State Drive 30 GBytes up to 960 GBytes (PCI Express™ M.2)

## 1. Product Summary

- **Capacities:**
  - 2280: 30 GBytes, 60 GBytes, 120 GBytes, 240 GBytes, 480 GBytes, 960 GBytes
  - 2260: 30 GBytes, 60 GBytes, 120 GBytes, 240 GBytes, 480 GBytes
  - 2242: 30 GBytes, 60 GBytes, 120 GBytes, 240 GBytes
- **Form Factors:**
  - 2280: PCI Express M.2 (2280) (80 mm x 22 mm x 3.3mm)
  - 2260: PCI Express M.2 (2260) (60 mm x 22 mm x 3.3 mm)
  - 2242: PCI Express M.2 (2242) (42 mm x 22 mm x 3.3 mm)
- **Compliance:** SATA Rev 3.1 – 6 Gbit/s (3 Gbit/s and 1.5 Gbit/s backward compatible)
- **Command Sets:** Supports ATA/ATAPI-8 and ACS-2 (2011/06/22)
- **Performance:**
  - Burst Transfer Rate: Up to 600 MBytes/s in SATA III – 6.0 Gbit/s
  - Read Performance: Sequential Read up to 520 MBytes/s, Random Read IOPs up to 75,000
  - Write Performance: Sequential Write up to 460 MB/s, Random Write IOPs up to 75,000
- **Operating Temperature Range<sup>1</sup>:**
  - Commercial: 0 °C to 70 °C
  - Industrial: -40 °C to 85 °C
- **Storage Temperature Range:** -40 °C to 85 °C
- **Operating Voltage:** 3.3 V ± 5%
- **Power (Max Capacity):**
  - Read (Active): 1.6 W
  - Write (Active): 3.4 W
  - Idle: 415 mW
  - Slumber: 115 mW
- **Data Retention:** 10 Years @ Life Begin; 1 Year @ Life End
- **Endurance:** TeraBytes Written (TBW) @ Max Capacity<sup>2</sup>
  - Client > 2165
  - Embedded > 595
  - Enterprise > 555
- **Shock/Vibration:** 1,500 g / 50 g
- **High-Performance 32-Bit Processor with Integrated, Parallel Flash Interface Engines:**
  - Multi-Level (MLC) NAND Flash
  - Hardware BCH Code ECC (up to 66 bit correction per 1 KByte page)
- **High Reliability:**
  - Mean Time Between Failure (MTBF): > 2,000,000 hours
  - Data Reliability: < 1 non-recoverable error per 10<sup>16</sup> bits read

<sup>1</sup> Adequate airflow is required to ensure the drive temperature, as reported in the S.M.A.R.T. data, does not exceed the specified maximum operating temperature.

<sup>2</sup> According to JEDEC (JESD471), the time to write the full TBW is 18 months. Higher average daily data volume reduces the specified TBW.

## 2. Product Features

- Best-in-Class Performance and Endurance with **durabit™** Technology
- Dynamic and Static Wear Leveling
- Subpage Mode Flash Translation Layer (FTL)
- Data Care Management
  - Active: Adaptive Read Refresh
  - Passive: Background Media Scan
- Lifetime Enhancements
  - Dynamic Bad Block Remapping
  - Write Amplification Reduction
- On-Board Power Fail Protection
- AHCI, TRIM, and NCQ Support
- ATA Security Feature Set Support
- DEVSLP Compatible
- In-Field Firmware Update
- Enterprise-Grade Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T.)
- 30 µinch Gold-Plated Connector (IPC-6012B Class 2 Compliant)
- Life Cycle Management
- Controlled "Locked" BOM
- RoHS-6 Compliant
- AES256 Encryption (on request)
- Swissbit Life Time Monitoring (SBLTM) Tool and SDK for SBLTM (on request)



### 3. Ordering Information

**Table 1: Standard Product List**

Capacity	2280	2260	2242
30 GBytes	SFSA030GMxAA1T0-t-LB-5y6-STD	SFSA030GMxAA1T0-t-LB-4y6-STD	SFSA030GMxAA1T0-t-LB-2y6-STD
60 GBytes	SFSA060GMxAA2T0-t-LB-5y6-STD	SFSA060GMxAA2T0-t-LB-4y6-STD	SFSA060GMxAA2T0-t-LB-2y6-STD
120 GBytes	SFSA120GMxAA4T0-t-LB-6y6-STD	SFSA120GMxAA4T0-t-LB-4y6-STD	SFSA120GMxAA2T0-t-HC-2y6-STD
240 GBytes	SFSA240GMxAA4T0-t-HC-6y6-STD	SFSA240GMxAA4T0-t-HC-4y6-STD	SFSA240GMxAA2T0-t-OC-2y6-STD
480 GBytes	SFSA480GMxAA4T0-t-OC-6y6-STD	SFSA480GMxAA4T0-t-OC-4y6-STD	Not Available
960 GBytes	SFSA960GMxAA8T0-t-OC-6y6-STD	Not Available	Not Available

x = product generation; t = temperature; y = firmware revision

**Table 2: Part Numbers Available for Ordering**

FW SBR11015			
Commercial Temperature			
Capacity	2280	2260	2242
30 GBytes	SFSA030GM1AA1T0-C-LB-516-STD	SFSA030GM1AA1T0-C-LB-416-STD	SFSA030GM1AA1T0-C-LB-216-STD
60 GBytes	SFSA060GM1AA2T0-C-LB-516-STD	SFSA060GM1AA2T0-C-LB-416-STD	SFSA060GM1AA2T0-C-LB-216-STD
120 GBytes	SFSA120GM1AA4T0-C-LB-616-STD	SFSA120GM1AA4T0-C-LB-416-STD	SFSA120GM1AA2T0-C-HC-216-STD
240 GBytes	SFSA240GM1AA4T0-C-HC-616-STD	SFSA240GM1AA4T0-C-HC-416-STD	SFSA240GM1AA2T0-C-OC-216-STD
480 GBytes	SFSA480GM1AA4T0-C-OC-616-STD	SFSA480GM1AA4T0-C-OC-416-STD	Not Available
960 GBytes	SFSA960GM3AA8T0-C-OC-626-STD	Not Available	Not Available
Industrial Temperature			
Capacity	2280	2260	2242
30 GBytes	SFSA030GM1AA1T0-I-LB-516-STD	SFSA030GM1AA1T0-I-LB-416-STD	SFSA030GM1AA1T0-I-LB-216-STD
60 GBytes	SFSA060GM1AA2T0-I-LB-516-STD	SFSA060GM1AA2T0-I-LB-416-STD	SFSA060GM1AA2T0-I-LB-216-STD
120 GBytes	SFSA120GM1AA4T0-I-LB-616-STD	SFSA120GM1AA4T0-I-LB-416-STD	SFSA120GM1AA2T0-I-HC-216-STD
240 GBytes	SFSA240GM1AA4T0-I-HC-616-STD	SFSA240GM1AA4T0-I-HC-416-STD	SFSA240GM1AA2T0-I-OC-216-STD
480 GBytes	SFSA480GM1AA4T0-I-OC-616-STD	SFSA480GM1AA4T0-I-OC-416-STD	Not Available
960 GBytes	SFSA960GM3AA8T0-I-OC-626-STD	Not Available	Not Available

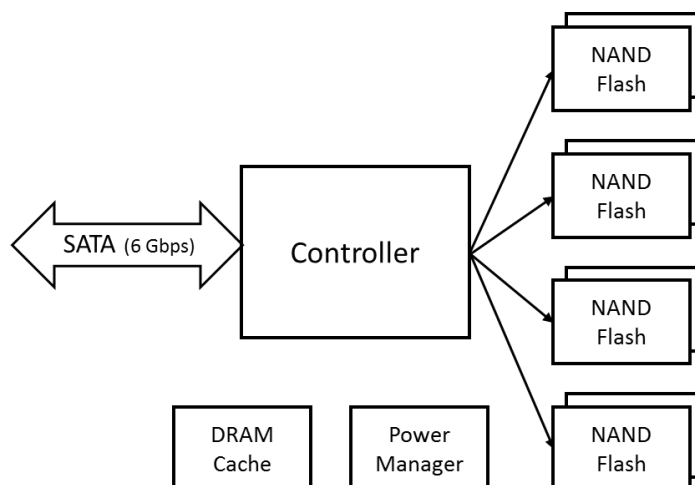
FW SBR13056			
Commercial Temperature			
Capacity	2280	2260	2242
960 GBytes	SFSA960GM3AA8T0-C-OC-626-STD	Not Available	Not Available
Industrial Temperature			
Capacity	2280	2260	2242
960 GBytes	SFSA960GM3AA8T0-I-OC-626-STD	Not Available	Not Available

<b>FW SBR12055</b>			
<b>Commercial Temperature</b>			
<b>Capacity</b>	<b>2280</b>	<b>2260</b>	<b>2242</b>
30 GBytes	SFSA030GM3AA1TO-C-LB-526-STD	SFSA030GM3AA1TO-C-LB-326-STD	SFSA030GM3AA1TO-C-LB-126-STD
60 GBytes	SFSA060GM3AA2TO-C-LB-526-STD	SFSA060GM3AA2TO-C-LB-326-STD	SFSA060GM3AA2TO-C-LB-226-STD
120 GBytes	SFSA120GM3AA4TO-C-LB-626-STD	SFSA120GM3AA4TO-C-LB-426-STD	SFSA120GM3AA2TO-C-HC-226-STD
240 GBytes	SFSA240GM3AA4TO-C-HC-626-STD	SFSA240GM3AA4TO-C-HC-426-STD	SFSA240GM3AA2TO-C-OC-226-STD
480 GBytes	SFSA480GM3AA4TO-C-OC-626-STD	SFSA480GM3AA4TO-C-OC-426-STD	Not Available
960 GBytes	Not Available	Not Available	Not Available
<b>Industrial Temperature</b>			
<b>Capacity</b>	<b>2280</b>	<b>2260</b>	<b>2242</b>
30 GBytes	SFSA030GM3AA1TO-I-LB-526-STD	SFSA030GM3AA1TO-I-LB-326-STD	SFSA030GM3AA1TO-I-LB-126-STD
60 GBytes	SFSA060GM3AA2TO-I-LB-526-STD	SFSA060GM3AA2TO-I-LB-326-STD	SFSA060GM3AA2TO-I-LB-226-STD
120 GBytes	SFSA120GM3AA4TO-I-LB-626-STD	SFSA120GM3AA4TO-I-LB-426-STD	SFSA120GM3AA2TO-I-HC-226-STD
240 GBytes	SFSA240GM3AA4TO-I-HC-626-STD	SFSA240GM3AA4TO-I-HC-426-STD	SFSA240GM3AA2TO-I-OC-226-STD
480 GBytes	SFSA480GM3AA4TO-I-OC-626-STD	SFSA480GM3AA4TO-I-OC-426-STD	Not Available
960 GBytes	Not Available	Not Available	Not Available

## 4. Product Description

The Swissbit® X-60m2 Solid State Drive (SSD) leverages the M.2 standard (formerly known as NGFF), which defines a variety of optional board sizes, and the connector supports both SATA and PCIe electrical interfaces. The SATA Gen III controller and Multi-Level Cell (MLC) NAND flash technology provides a robust, non-volatile storage solution for today's embedded computing applications. A functional block diagram of the X-60m2 SSD is provided below in Figure 1.

Figure 1: X-60m2 Functional Block Diagram



The X-60m2 SSD incorporates a 75-position edge connector with B and M keys to support host read/write, control, and power activity per the applicable JEDEC and SATA IO specifications<sup>3</sup>.

The on-board SATA III controller manages the interface between the host and the non-volatile NAND flash memory array. The controller is designed to support SATA Gen III (6 Gbit/s) interface speeds and is fully backward compatible with SATA Gen II (3 Gbit/s) and SATA Gen I (1.5 Gbit/s) to enable the broadest possible range of platform compatibility. The controller utilizes an ARC 700 processing core, providing an optimum balance between read/write performance, Data Care Management, and power fail protection.

Swissbit's **durabit™** X-60m2 SSDs deliver an impressive IOPS rate and highest endurance by combining MLC flash technology with a high-end controller architecture, firmware, and an optimized configuration. The **durabit™** SSDs are designed for applications requiring high data transfer rates (see Table 3: Read/Write Performance (SBR1105, SBR120155, SBR13056)). This performance is achieved through an on-board DRAM cache and the controller 4-channel NAND flash interface that supports ONFI and Toggle 2 (400 MT/s) interface speeds. In addition, the X-60m2 series feature Swissbit's proven power fail safety and support for the ATA security feature set, NCQ, TRIM, advanced wear leveling and bad block management, and in-field firmware updates.

An on-controller BCH Error Correction Code (ECC) engine provides the X-60m2 hardware ECC, which is capable of correcting up to 66 bits per 1 KByte page. This engine, combined with Swissbit's Data Care Management firmware, provides both passive and active data management strategies to ensure data integrity and extract the maximum possible endurance and reliability from the NAND flash array. These strategies include, but are not limited to, Global Wear Leveling, Adaptive Read Refresh, Background Media Scan, and Dynamic Block Remapping.

The risk of data loss as a result of an unexpected power fail event is mitigated using a robust sequence of voltage regulators and detectors designed to ensure a graceful shutdown of the controller and NAND flash array. A combination of both hardware and firmware power fail features prevent the possibility of resident data being corrupted during an unexpected power failure.

<sup>3</sup> SerialATA IO rev 3.2 Section 6.6, Aug 7, 2013  
<https://www.jedec.org/standards-documents/focus/flash/solid-state-drives>  
<https://www.sata-io.org/sata-m2-card>  
<http://pcsig.com/specifications Nov 2013>

## Related Documentation

- Serial Transport Protocols and Physical Interconnect (ATA/ATAPI-8)
- AT Attachment Interface Document, American National Standards Institute, X3.298-1997
- PCI Express M.2 standard – PCI Express M.2 Specification, Revision 0.9, June 18, 2013

## 4.1 Performance Specifications

The X-60m2 read/write sequential and random I/O performance benchmarks are detailed below in Table 3.

**Table 3: Read/Write Performance (SBR1105, SBR120155, SBR13056)<sup>4</sup>**

Drive Capacity	Sequential Read (MBPS)		Sequential Write (MBPS)		Random Read (IOPs)		Random Write (IOPs)	
	2242	2260/2280	2242	2260/2280	2242	2260/2280	2242	2260/2280
30 GBytes	280	280	50	50	26,500	26,500	11,500	11,500
60 GBytes	520	520	90	90	51,000	51,000	23,000	23,000
120 GBytes	520	520	180	185	71,000	73,500	43,000	45,500
240 GBytes	520	520	340	355	72,000	75,000	78,000	75,000
480 GBytes	NA	520	NA	450	NA	75,000	NA	75,000
960 GBytes	NA	520	NA	460	NA	75,000	NA	75,000

## 4.2 Current Consumption

The drive-level current consumption as a function of operating mode is shown below in Table 4.

**Table 4: Current Consumption (SBR1105, SBR13056, SBR120155)<sup>5</sup>**

Drive Capacity	2260 and 2280						Unit
	Sequential Read	Sequential Write	Random Read	Random Write	Idle	Slumber	
30 GBytes	265	265	255	265	105	35	mA
60 GBytes	365	370	330	365	110	35	
120 GBytes	405	500	375	500	110	35	
240 GBytes	440	805	415	800	110	35	
480 GBytes	440	960	420	950	115	35	
960 GBytes	470	1020	430	1020	125	35	
Drive Capacity	2242						Unit
	Sequential Read	Sequential Write	Random Read	Random Write	Idle	Slumber	
30 GBytes	265	265	255	265	105	35	mA
60 GBytes	365	370	330	365	110	35	
120 GBytes	380	485	355	485	105	35	
240 GBytes	390	495	360	495	110	35	

<sup>4</sup> The values are measured using CDM across the full drive density. Performance depends on flash type and number, file/cluster size, and burst speed.

<sup>5</sup> All values are the maximum recorded at 25 ° C, with nominal supply voltage, and SATA III performance test with IOMeter (512 byte-1 MByte transfer sizes).



### 4.3 Environmental Specifications

#### 4.3.1 Recommended Operating Conditions

The recommended operating conditions for the X-60m2 SSD are provided in Table 5 below.

**Table 5: Recommended Operating Conditions<sup>6</sup>**

Parameter	Value
Commercial Operating Temperature	0 °C to 70 °C
Industrial Operating Temperature	-40 °C to 85 °C
Power Supply V <sub>CC</sub> Voltage	3.3 V ± 5%

#### 4.3.2 Recommended Storage Conditions

The recommended storage conditions are listed below in Table 6.

**Table 6: Recommended Storage Conditions**

Parameter	Value
Commercial Storage Temperature	-40 °C to 85 °C
Industrial Storage Temperature	-40 °C to 85 °C

#### 4.3.3 Shock, Vibration and Humidity

The maximum shock, vibration and humidity conditions are listed below in Table 7.

**Table 7: Shock, Vibration, and Humidity**

Parameter	Value
Non-Operating Shock	1,500 g, 0.5 ms pulse duration, half-sine wave (IEC 60068-2-27 and JESD22-B110 cond. B)
Non-Operating Vibration	50 g, 131-2,000 Hz, 3 axes, 12 cycles (IEC 60068-2-6, MIL-STD-893 H Method 2007.3)
Humidity (Non-Condensing)	85% RH 85 °C, 1000 hrs, max. supply voltage (JESD22-A101B)

<sup>6</sup> Adequate airflow is required to ensure the drive temperature, as reported in the S.M.A.R.T. data, does not exceed the specified maximum operating temperature.

#### 4.4 Regulatory Compliance

The X-60m2 devices comply with the standards listed in the following table.

**Table 8: Regulatory Compliance**

Compliance	Country	Type	Standard(s)/Directive
CE	European Union	Certificate	2011/65/EU, 2012/19/EU, 2014/30/EU
CE/EMC	European Union	Compliance	2004/108/EC (AS/NZS CISPR22 :2009 +A1:2010, EN 61000-6-2:2005/AC:2005, EN 61000-6-4:2007/A1:2011 [EN55022:2010 Class B])
CE/RoHS	European Union	Compliance	2011/65/EU
CE/WEEE	European Union	Compliance	2012/19/EU
REACH	European Union	Certificate	1907/2006
FCC	United States	Certificate	47CFR Part 15, Class B
UL	United States	Compliance	UL/CSA 60950-1, Second Edition
VCCI	Japan	Compliance	ITE (Class A)
CCC	China	Compliance	Laws and Regulations of the People's Republic of China Governing Foreign-Related Matters (1991.7)
C-Tick	Australia	Compliance	AS/NZS CISPR22
TüV	Germany	Compliance	TüV IEC 60950-1; UL/CSA 60950-1, Second Edition
SATA-IO	International	Compliance	SATA Revision 1.4 Interoperability

#### 4.5 Mechanical Specifications

The X-60m2 SSD consists of a flash controller and NAND flash memory devices. The controller interfaces with a host system, allowing data to be written to and read from the flash memory array. The SSD has a PCIe mini connector with a SATA interface. Physical dimensions are detailed in Table 9 below. Figure 3 on page 13 illustrates the X-60m2 dimensions and connector location.

**Table 9: Measured Physical Dimensions**

Physical Dimensions	2280	2260	2242	Unit
Length	80.00±0.15	60.00±0.15	42.00±0.15	mm
Width	22.00±0.15	22.00±0.15	22.00±0.15	
Thickness (Max Capacity)	3.30±0.08	3.30±0.08	3.30±0.08	
Weight (2280 Max Capacity)	10.2			g

## 4.6 Reliability and Endurance

The Mean Time Between Failure (MTBF) is specified to exceed the value listed below. Data reliability with effective error tolerance and data retention at the beginning and end of life is also provided.

**Table 10: Reliability**

Parameter	Value
MTBF (at 25 °C)	> 2,000,000 hours
Data Reliability	< 1 Non-Recoverable Error per 10 <sup>16</sup> bits Read
Data Retention	10 Years at Start (JESD47), 1 Year at EOL

Endurance represented as both TeraBytes Written (TBW) and Drive Writes Per Day (DWPD) for three different application scenarios is provided in the following table.

**Table 11: Endurance**

Drive Capacity	Client		Enterprise		Embedded	
	TBW	DWPD	TBW	DWPD	TBW	DWPD
30 GBytes	67.74	1.98	17.44	0.51	18.75	0.55
60 GBytes	135.48		34.88		37.50	
120 GBytes	270.95		69.74		75.00	
240 GBytes	541.91		139.52		150.00	
480 GBytes	1083.82		279.04		300.00	
960 GBytes	2167.63		558.07		600.00	

## 4.7 Drive Geometry Specification

The X-60m2 drive geometry is set to report industry-standard LBA settings per the IDEMA standard (LBA1-03). The values for each capacity are shown below in Table 12.

**Table 12: Drive Geometry**

Drive Capacity	User Capacity <sup>7</sup>	Total LBA	User Addressable Bytes
		Decimal	(Unformatted)
32 GBytes	30 GBytes	58,626,288	30,016,659,456
64 GBytes	60 GBytes	117,231,408	60,022,480,896
128 GBytes	120 GBytes	234,441,648	120,034,123,776
256 GBytes	240 GBytes	468,862,128	240,057,409,536
512 GBytes	480 GBytes	937,703,088	480,103,981,056
1024 GBytes	960 GBytes	1,875,385,008	960,197,124,096

<sup>7</sup> 1 GByte = 10<sup>9</sup> bytes

## 5. Electrical Interface

This 75-position M.2 connector incorporates both the B and M keys for Socket 2 SATA-based SSDs and follows the applicable JEDEC specifications. M.2 SSDs follow the SATA I/O specification, offering a maximum performance of 6 Gbit/s.

Figure 2: X-60m2 Electrical Interface

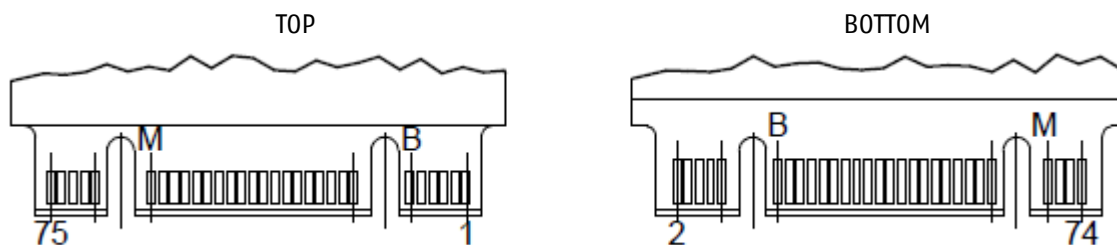


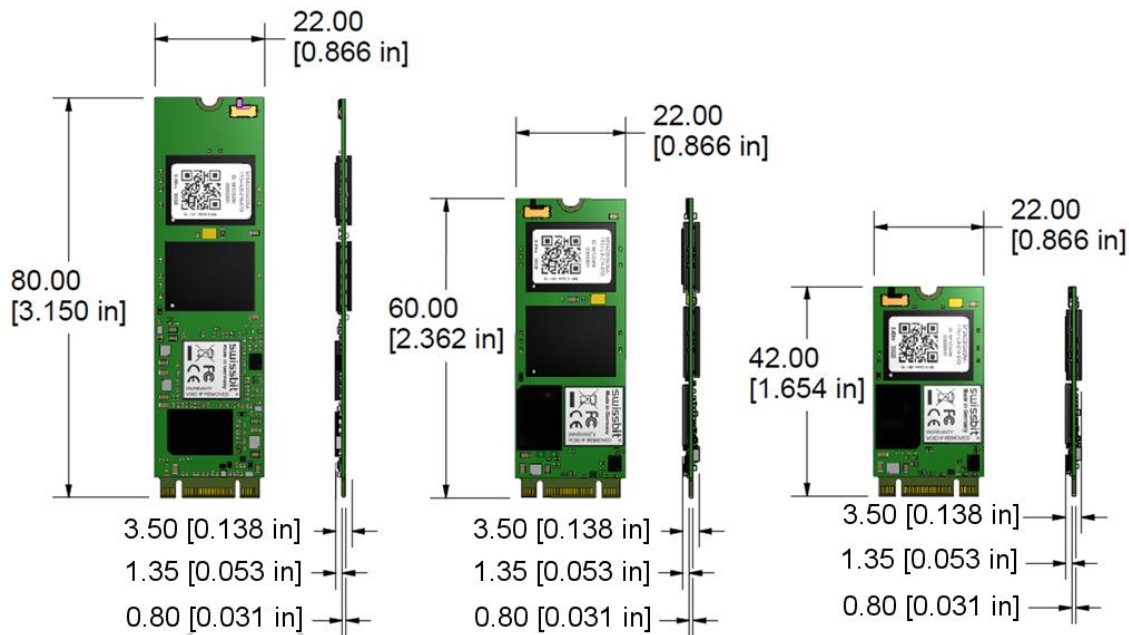
Table 13: Pin Assignment, Name, and Description

Description	Assignment	Pin	Pin	Assignment	Description
Config_3	GND	1	2	+3.3V	3.3V Source
Ground	GND	3	4	+3.3V	3.3V Source
No Connect	NC	5	6	NC	No Connect
No Connect	NC	7	8	NC	No Connect
No Connect	NC	9	10	DAS/DSS	DEVACT Device Activity Signal
No Connect	NC	11	12-19	Removed	Mechanical Notch B
Reserved	NC	20	21	GND	CONFIG_o
Reserved	NC	22	23	NC	No Connect
Reserved	NC	24	25	NC	No Connect
Reserved	NC	26	27	GND	Ground
No Connect	NC	28	29	NC	No Connect
No Connect	NC	30	31	NC	No Connect
No Connect	NC	32	33	GND	Ground
Reserved	NC	34	35	NC	No Connect
Reserved	NC	36	37	NC	No Connect
Device Sleep, Input	DEVSLP	38	39	GND	Ground
Reserved	NC	40	41	B+	+SATA Differential Receive Signal
Reserved	NC	42	43	B-	-SATA Differential Receive Signal
No Connect	NC	44	45	GND	Ground
Reserved	NC	46	47	A-	-SATA Differential Transmit Signal
Reserved	NC	48	49	A+	+SATA Differential Transmit Signal
No Connect	NC	50	51	GND	Ground
No Connect	NC	52	53	NC	No Connect
No Connect	NC	54	55	NC	No Connect
Reserved	NC	56	57	GND	Ground
Reserved	NC	58	59-66	Removed	Mechanical Notch M
No Connect	NC	67	68	NC	No Connect
Config_1	GND	69	70	3.3V	Supply pin, 3.3V
Ground	GND	71	72	3.3V	Supply pin, 3.3V
Ground	GND	73	74	3.3V	Supply pin, 3.3V
Config_2	GND	75			

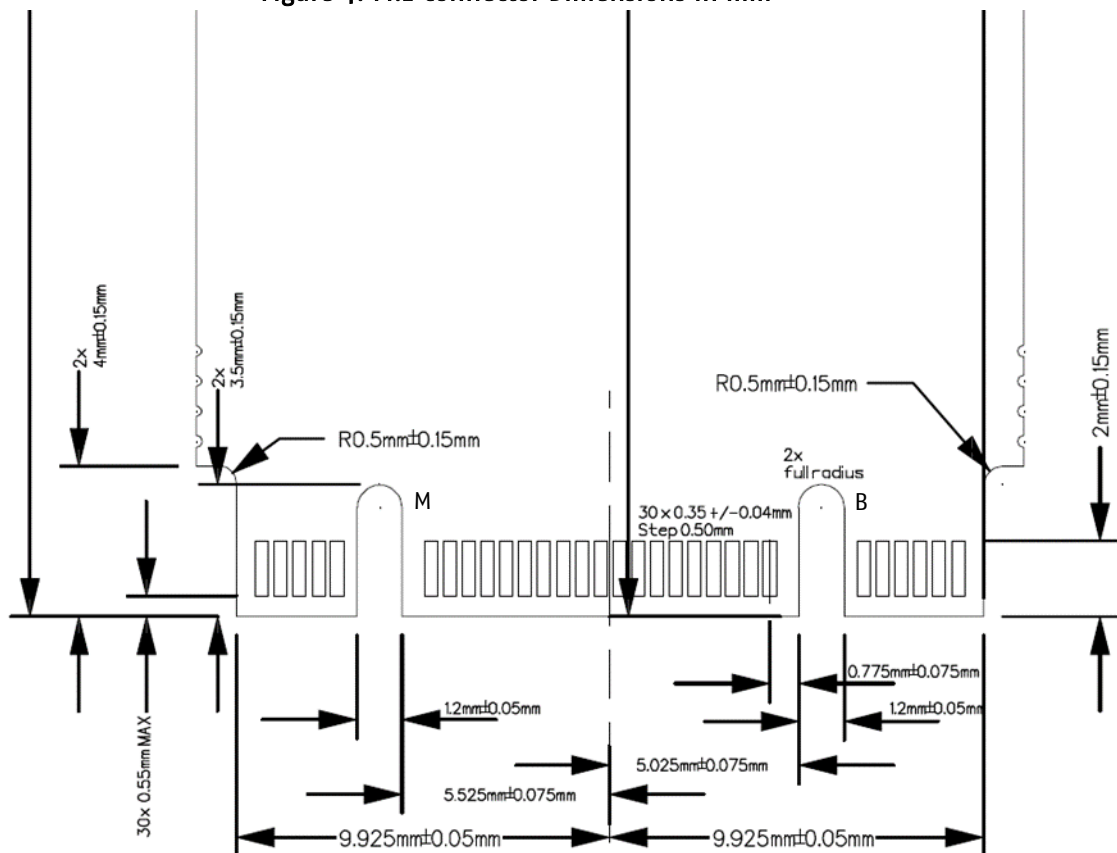
## 6. Package Mechanical

**NOTE:** The dimensions in the following figure are the maximum values based on the JEDEC standard. For the product dimensions, see the *Mechanical Specifications* section on page 10.

**Figure 3: M.2 SSD Drive Dimensions in mm [in]**



**Figure 4: M.2 Connector Dimensions in mm**



## 7. ATA Commands

This section provides information on the ATA commands supported by the SSD. The commands are issued to the ATA by loading the required registers in the command block with the supplied parameter, and then writing the command code to the register. For backward compatibility, some commands are implemented as a "no operation". See Table 14 for a list of ATA commands the device supports. For details about setting up the command registers, see the latest ATA Specification.

**Table 14: ATA Command Set**

Command	Code	Protocol
<b>General Feature Set</b>		
Execute Device Diagnostic	90h	Execute Device Diagnostic
Flush Cache	E7h	Non-data
Identify Device	ECh	PIO data-in
Initialize Drive Parameters	91h	Non-data
Read DMA	C8h	DMA
Read Log Ext	2Fh	PIO data-in
Read Multiple	C4h	PIO data-in
Read Sector(s)	20h	PIO data-in
Read Verify Sector(s)	40h or 41h	Non-data
Set Feature	EFh	Non-data
Set Multiple Mode	C6h	Non-data
Write DMA	CAh	DMA
Write Multiple	C5h	PIO data-out
Write Sector(s)	30h	PIO data-out
NOP	00h	Non-data
Read Buffer	E4h	PIO data-in
Write Buffer	E8h	PIO data-out
<b>Power Management Feature Set</b>		
Check Power Mode	E5h or 98h	Non-data
Idle	E3h or 97h	Non-data
Idle Immediate	E1h or 95h	Non-data
Sleep	E6h or 99h	Non-data
Standby	E2h or 96h	Non-data
Standby Immediate	E0h or 94h	Non-data
<b>Security Mode Feature Set</b>		
Security Set Password	F1h	PIO data-out
Security Unlock	F2h	PIO data-out
Security Erase Prepare	F3h	Non-data
Security Erase Unit	F4h	PIO data-out
Security Freeze Lock	F5h	Non-data
Security Disable Password	F6h	PIO data-out
<b>S.M.A.R.T. Feature Set</b>		
S.M.A.R.T. Disable Operations	Boh	Non-data
S.M.A.R.T. Enable/Disable Autosave	Boh	Non-data
S.M.A.R.T. Enable Operations	Boh	Non-data
S.M.A.R.T. Execute Off-Line Immediate	Boh	Non-data
S.M.A.R.T. Read Data	Boh	PIO data-in
S.M.A.R.T. Read Log	Boh	PIO data-in
S.M.A.R.T. Read Threshold	Boh	PIO data-in
S.M.A.R.T. Return Status	Boh	Non-data
S.M.A.R.T. Save Attribute Values	Boh	Non-data
S.M.A.R.T. Write Attribute Values	Boh	Non-data
S.M.A.R.T. Write Log	Boh	PIO data-out

Command	Code	Protocol
<b>Host Protected Area Feature Set</b>		
Read Native Max Address	F8h	Non-data
Set Max Address	F9h	Non-data
Set Max Set Password	F9h	PIO data-out
Set Max Lock	F9h	Non-data
Set Max Freeze Lock	F9h	Non-data
Set Max Unlock	F9h	PIO data-out
<b>48-Bit Address Feature Set</b>		
Flush Cache Ext	EAh	Non-data
Read Sector(s) Ext	24h	PIO data-in
Read DMA Ext	25h	DMA
Read Multiple Ext	29h	PIO data-in
Read Native Max Address Ext	27h	Non-data
Read Verify Sector(s) Ext	42h	Non-data
Set Max Address Ext	37h	Non-data
Write DMA Ext	35h	DMA
Write DMA FUA Ext	3Dh	DMA
Write Multiple Ext	39h	PIO data-out
Write Multiple FUA Ext	CEh	PIO data-out
Write Sector(s) Ext	34h	PIO data-out
<b>NCQ Feature Set</b>		
Read FPDMA Queued	60h	DMA Queued
Write FPDMA Queued	61h	DMA Queued
<b>Others</b>		
Data Set Management	06h	DMA
Seek	70h	Non-data

## 8. Identify Device Information

The following table describes the 512 bytes of data the drive returns for the Identify Device command (ECh).

**Table 15: Identify Device Information**

Word(s)	Default Value	Total Bytes	Data Field Type Information
0	0040h*	2	Standard Configuration Fixed (optional 848Ah for removable)
1	XXXXh	2	Default number of cylinders
2	0000h	2	Reserved
3	00XXh	2	Default number of heads
4-5	0000h	4	Obsolete
6	XXXXh	2	Default number of sectors per track
7-8	XXXXh	4	Number of sectors per Drive (Word 7 = MSW, Word 8 = LSW)
9	0000h	2	Obsolete
10-19	aaaa	20	Serial number in ASCII (right-justified)
20-22	0000h	6	Obsolete
23-26	XXXX*	8	Firmware revision in ASCII (big-endian byte order in Word)
27-46	XXXX*	40	Model number in ASCII (right-justified)
47	8002h	2	Maximum number of sectors on Read/Write Multiple command
48	4000h	2	Trusted Computing feature set not supported
49	2F00h*	2	Standby Timer, DMA, LBA, IORDY supported
50	4000h	2	Capabilities
51	0000h	2	PIO data transfer cycle timing mode 0
52	0000h	2	Obsolete
53	0007h*	2	Words 88 and 64-70 valid
54	XXXXh	2	Current numbers of cylinders
55	XXXXh	2	Current numbers of heads
56	XXXXh	2	Current sectors per track
57-58	XXXXh	4	Current capacity in LBAs (Word 57 = LSW, Word 58 = MSW)
59	910Xh*	2	Multiple sector setting (host changeable)
60-61	XXXXh	4	Total number of sectors addressable in LBA Mode
62	0000h	2	Obsolete
63	0007h*	2	Multiword DMA transfer support modes 2, 1, and 0 (host changeable)
64	0003h	2	Advanced PIO modes supported
65	0078h*	2	Minimum Multiword DMA transfer cycle time per Word
66	0078h*	2	Recommended Multiword DMA transfer cycle time
67	0078h*	2	Minimum PIO transfer cycle time without flow control
68	0078h*	2	Minimum PIO transfer cycle time with IORDY flow control
69	4D20h	2	Trimmed range returning zeros, 28-bit commands supported, download
70-74	0000h	10	Reserved
75	001Fh	1	Queue Depth
76	830Eh	2	SATA Capabilities
77	0086h	1	Additional SATA Capabilities
78	014Ch	2	SATA feature support
79	0040h*	2	SATA features enabled (host changeable)
80	03F0h	2	Major revision
81	0000h	2	Minor revision
82 -84	746Bh*	6	Features/command sets supported
85-87	7469h*	6	Features/command sets enabled (may change in operation)
88	407Fh*	2	UDMA mode supported
89	0002h*	2	Time for security erase unit completion
90	0002h*	4	Time for enhanced security erase time
91	0000h	2	Power Management
92	FFFEh*	2	Master password revision code



Word(s)	Default Value	Total Bytes	Data Field Type Information
93-99	0000h*	70	Reserved
100-103	XXXXh	8	Max user LBA48 address feature set
104-105	0000h	4	Reserved
106	4000h	2	Sector size
107-118	0000h	24	Reserved
119-120	4018h	4	Command set supported settings
121-127	0000h	14	Reserved
128	0021h*	2	Security status (may change in operation)
129-159	XXXXh	62	"Swissbit SSD"
160	0000h*	2	Power requirement
161	0000h	2	Reserved
162	0000h	2	Management schemes
163	0000h	2	IDE Timing
164	0000h	2	I/O Timing
165-168	0000h	8	Reserved
169	0001h	2	Data Set Management supported
170-208	XXXXh	78	Reserved
209	4000h	2	Logical block alignment
210-216	0000h	14	Reserved
217	0001h*	2	Nominal media rotation rate: Solid State Device
218-221	0000h	8	Reserved
222	107Fh	2	Transport major revision
223-233	0000h	22	Reserved
234	0001h	2	Minimum number of 512-byte units per segmented download
235	0200h	2	Maximum number of 512-byte units per segmented download
236-254	0000h	38	Reserved
255	XXXXh	2	Integrity Word

\* Standard values for full functionality are listed. Values depend on device configuration.

## 9. S.M.A.R.T. Functionality

The X-60m2 SSDs fully support the ATA Specification for Self-Monitoring, Analysis, and Reporting Technology (S.M.A.R.T.). For details about the S.M.A.R.T. subcommands and attributes, see the *S.M.A.R.T. Attribute Technical Reference Guide*.

### 9.1 S.M.A.R.T. Subcommands

The following table lists the supported S.M.A.R.T. subcommands and the Features register values.

**Table 16: S.M.A.R.T. Features Supported**

Features	Operation
D0h	S.M.A.R.T. Read Data
D1h	S.M.A.R.T. Read Attribute Thresholds
D2h	S.M.A.R.T. Enable/Disable Autosave
D3h	S.M.A.R.T. Save Attribute Values
D4h	S.M.A.R.T. Execute Off-Line Immediate
D5h	S.M.A.R.T. Read Log
D6h	S.M.A.R.T. Write Log
D7h	S.M.A.R.T. Write Attribute Thresholds
D8h	S.M.A.R.T. Enable Operations
D9h	S.M.A.R.T. Disable Operations
DAh	S.M.A.R.T. Return Status

The device aborts any S.M.A.R.T. subcommands with Features register values not listed in the above table.

## 9.2 S.M.A.R.T. Read Data

When the drive receives the S.M.A.R.T. Read Data subcommand, it returns one sector (512 bytes) of data. See the following table for the data structure of this sector.

**Table 17: S.M.A.R.T. Data Structure**

Byte(s)	Value	Description
0-1	0100h	S.M.A.R.T. structure version
2-361	XXh	Attribute entries 1 to 30 (see Table 19)
362	00h	Off-line data collection status (no off-line data collection started)
363	00h	Self-test execution status byte (self-test completed)
364-365	0000h	Total time, in seconds, to complete off-line data collection
366	00h	Vendor specific
367	00h	Off-line data collection capability (no off-line data collection)
368-369	0002h	S.M.A.R.T. capabilities
370	01h	Error logging capability
371	00h	Vendor specific
372	01h	Short self-test routine recommended polling time, in minutes
373	01h	Extended self-test routine recommended polling time, in minutes
374	01h	Conveyance self-test routine recommended polling time, in minutes
375-385	00h	Reserved
386-395	XXh	Firmware version in ASCII
396-399	00h	Reserved
400-405	XXh	Controller model in ASCII ("SM2246")
406-510	00h	Reserved
511	XXh	Data structure checksum

## 9.3 S.M.A.R.T. Attributes

The X-60m2 drives support the S.M.A.R.T. attributes listed in the following table.

**Table 18: S.M.A.R.T. Attributes**

ID	Worst	Threshold	Attribute	Description
01h	100	0	Raw Read Error Rate	Total number of Cyclic Redundancy Check (CRC) errors that occurred over the SATA interface
05h	100	0	Reallocated Sector Count	Total number of runtime identified (field marked) bad blocks
09h	100	0	Power-On Hours	Total hours that the device has been powered on and operational (not in Sleep mode)
0Ch	100	0	Power Cycle Count	Total number of power cycles that have occurred during the life of the drive
A0h	100	0	Uncorrectable Sector Count	Total number of sectors read (active or passive) with UECC errors
A1h	100	0*	Spare Blocks	Total number of spare blocks currently available
A3h	100	0	Number of Initial Invalid Blocks	Total number of initially identified (factory marked and pretest) bad blocks
A4h	100	0	Total Erase Count	Total number of erase operations that have ever been performed on all currently valid blocks (excluding the system, bad and reserved blocks)
A5h	100	0	Maximum Erase Count	The maximum number of erase operations that have ever been performed on a single block (excluding the system, bad and reserved blocks)
A6h	100	0	Minimum Erase Count	The minimum number of erase operations that have ever been performed on a single block (excluding the system, bad and reserved blocks)
A7h	100	0*	Average Erase Count	The average number of erase operations that have ever been performed on a single block (excluding the system, bad and reserved blocks)

ID	Worst	Threshold	Attribute	Description
A8h	100	0	Maximum Specified Erase Count	The specified maximum erase count; equivalent to number of program/erase (P/E) cycles rated for the device
A9h	100	0	Power on UECC Count	The number of uncorrectable errors encountered during a power up event
C0h	100	0	Initial Spare Block Count	Total number of original spare blocks
C1h	100	0	Dynamic Remaps	Total number of dynamic remap operations
C2h	100	0	Temperature	Temperature (minimum, maximum, and current) of the device
C3h	100	0	Flash ECC Recovered	Total number of times the read-retry process was required to recover data
C4h	0	0	Reallocation Event Count	Total count of remapping operations
C6h	100	0	Uncorrectable Sector Count Offline	Total number of sectors read (active only) with UECC errors
C7h	100	0	SATA PHY CRC Error Count	Total count of PHY errors (including CRC) that occurred over the interface cable
D7h	100	0	TRIM Count	Total number of TRIM commands issued by the host
EBh	100	0	Total Flash LBAs Written	The lower 7 bytes of the total number of LBAs (in 32 KByte increments) written to the flash; the higher 5 bytes are located in attribute EDh
EDh	100	0	Total Flash LBAs Written Expanded	The upper 5 bytes of the total number of LBAs (in 32 KByte increments) written to the flash; the lower 7 bytes are located in attribute EBh
F1h	100	0	Total Host LBAs Written	The lower 7 bytes of the total number of LBAs written to the device by the host; the higher 5 bytes are located in attribute F3h
F2h	100	0	Total Host LBAs Read	The lower 7 bytes of the total number of LBAs read from the device by the host; the higher 5 bytes are located in attribute F4h
F3h	100	0	Total Host LBAs Written Expanded	The upper 5 bytes of the total number of LBAs written to the device by the host; the lower 7 bytes are located in attribute F1h
F4h	100	0	Total Host LBAs Read Expanded	The upper 5 bytes of the total number of LBAs read from the device by the host; the lower 7 bytes are located in attribute F2h
F8h	100	0	SSD Remaining Life	Percent of SSD life remaining on the SSD (a value from 0 to 64h), normalized to 100; based upon Average Erase Count (A7h) scaled by the Maximum Specified Erase Count (A8h)
F9h	100	0	Spare Block Remaining Life	Percent of spare blocks remaining

\* These threshold values are changeable using the Write Attribute Thresholds command.

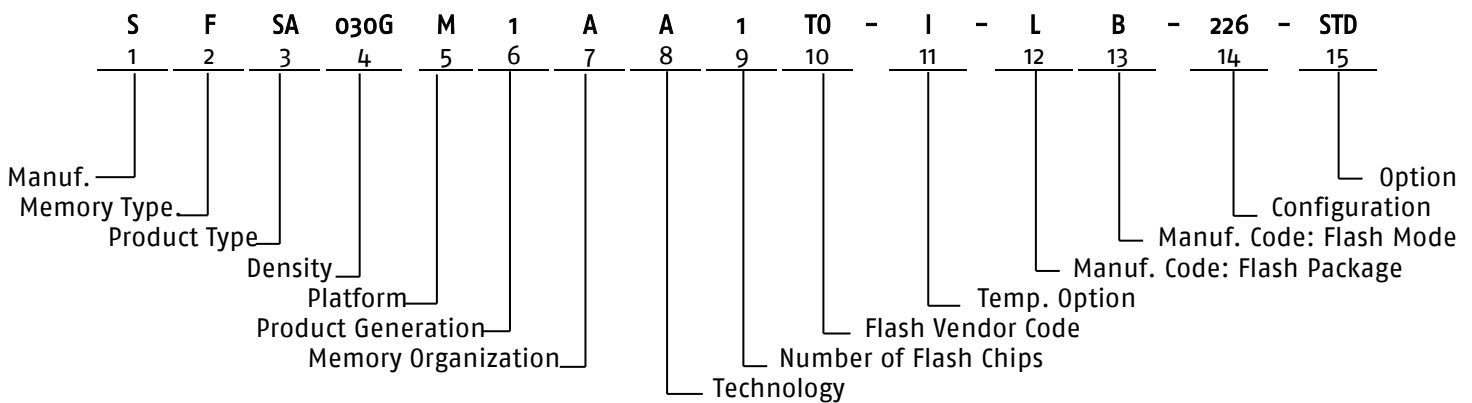
#### 9.4 S.M.A.R.T. Attribute Entry Structure

Each attribute entry consists of 12 bytes. See the following table for the data structure of each entry.

Table 19: Attribute Entry

Byte(s)	Value	Description
0	XXh	Attribute ID (see Table 18)
1-2	XXXXh	Flags (little-endian)
3	XXh	Attribute value as a percentage
4	XXh	Worst value as a percentage
5-8	XXXXh	Raw value (little-endian)
9-11	00h	Reserved

## 10. Part Number Decoder



### 10.1 Manufacturer

Swissbit code	S
---------------	---

### 10.2 Memory Type

Flash	F
-------	---

### 10.3 Product Type

SATA Interface	SA
----------------	----

### 10.4 Density

30 GBytes	030G
60 GBytes	060G
120 GBytes	120G
240 GBytes	240G
480 GBytes	480G
960 GBytes	960G

### 10.5 Platform

M.2 SSD	M
---------	---

### 10.6 Product Generation

### 10.7 Memory Organization

x8	A
----	---

### 10.8 Technology

X-60m2 Series	A
---------------	---

### 10.9 Number of Flash Chips

1 Flash	1
2 Flash	2
4 Flash	4
8 Flash	8

### 10.10 Flash Code

Toshiba	T0
---------	----

### 10.11 Temperature Option

Industrial Temperature Range: -40 °C to 85 °C	I
Standard Temperature Range: 0 °C to 70 °C	C

### 10.12 Die Classification

MLC MONO (single die package)	G
MLC DDP (dual die package)	L
MLC QDP (quad die package)	H
MLC ODP (octal die package)	O

### 10.13 Pin Mode

	TSOP	BGA
Single nCE and Single R/nB	S	A
Dual nCE and Dual R/nB	T	B
Quad nCE and Quad R/nB	U	C
Octal nCE and Octal R/nB	*	V
Sexdec nCE & Sexdec R/nB	*	W

\*Not Available

### 10.14 Drive Configuration XYZ

#### X = Dimension and Flash Assembly

Dimension	Assembly	X
2242	Single-Sided	1
2242	Double-Sided	2
2260	Single-Sided	3
2260	Double-Sided	4
2280	Single-Sided	5
2280	Double-Sided	6

#### Y = Firmware Revision

FW Revision	Y
SBR11015 for 30GB up to 480GG	1
SBR120155 for 30GB up to 480GG	2
SBR13056 for 960GB	2

#### Z = Max Transfer Mode

Max PIO Mode/CIS	Z
UDMA6 (MDMA2, PIO4)	6

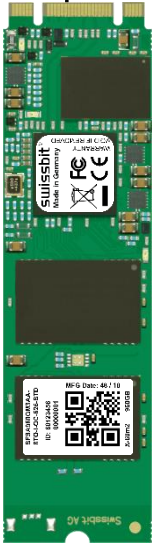
### 10.15 Option

Swissbit/Standard	STD
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# 11. Swissbit M.2 SSD Marking Specification

## 11.1 Top View

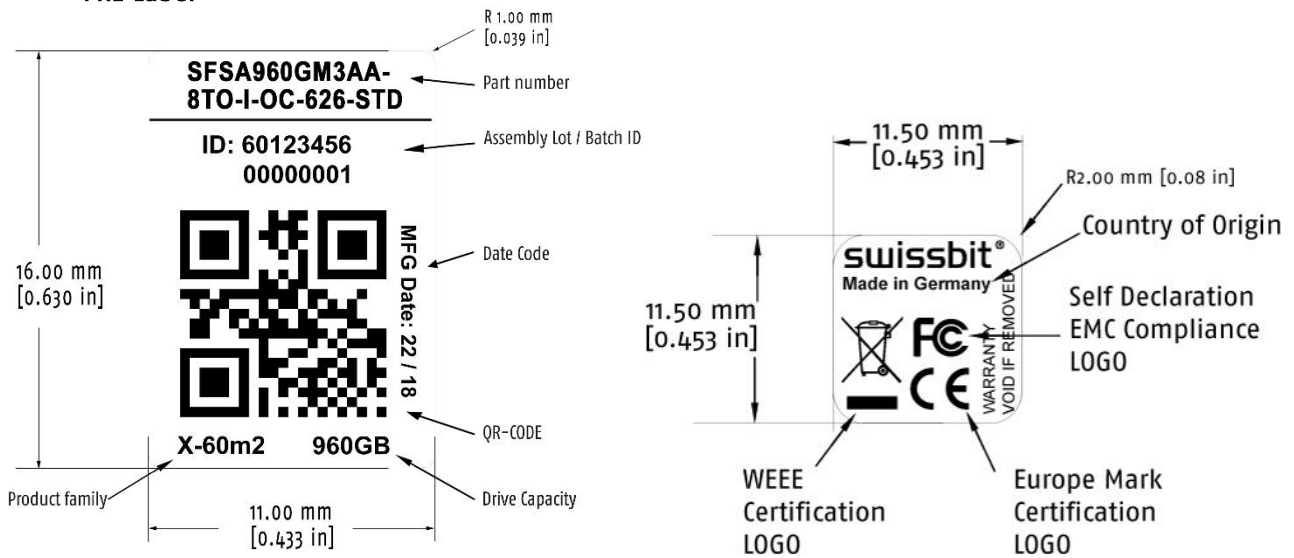
Example: 2280



## 11.2 Label Content

- Part Number
- Lot Code/Identification
- Type Code
- Density
- Manufacturing Date
- Swissbit Logo
- Country of Origin
- CE Logo
- FCC Logo
- WEEE Logo

### M.2 Label



## 12. Revision History

**Table 20: Document Revision History**

Date	Revision	Description	Revision Details
3-Sept-2015	0.90	First preliminary release	
12-Sept-2015	0.91	Updated connector drawing and spare block attributes.	
24-Sept-2015	1.00	Updated RoHS, ACPEIP and WEEE declaration, product pictures, feature icons and the physical dimensions.	Doc. req. no. 0787
13-Nov-2015	1.01	Added full X type options in Drive Configuration to include m.2 types, formatted tables, fixed typo and added sector data for some security commands.	Doc. req. no. 0823
4-Jan-2016	1.02	Removed ATA command byte structure. Updated Identify Device and S.M.A.R.T. information. Updated performance and current values. Added DEVSLP compatible to list of features. Added slumber current. Added Write Thresholds command. Updated storage temperature. Updated copyright date.	Doc. req. no. 0911
2-Feb-2016	1.03	Fixed formatting issue.	Doc. req. no. 0969
22-Mar-2016	1.04	Added JEDEC information for endurance workloads. Added FUA command support. Updated part number decoder. Added regulatory information.	Doc. req. no 1022
27-Jun-2016	1.05	Added available part number table. Added footnote regarding TBW.	Doc. req. no 1147
31-Aug-2016	1.06	Fixed typo.	Doc. req. no. 1250
4-Nov-2016	1.07	Corrected endurance values and updated mechanical drawing.	Doc. req. no. 1353
6-Dec-2016	1.08	Corrected shock and vibration methods.	Doc. req. no. 1417
8-Feb-2017	1.09	Added 30 pin gold-plated connector information. Updated copyright date.	Doc. req. no. 1518
24-May-2018	1.10	Added 960 GByte density (current values TBD). Updated firmware info (chapters device info and S.M.A.R.T. read data), endurance values, test-conditions and part-number decoder (pin mode), changed label illustrations	Doc. req. no. 2224
28-Nov-2018	1.11	Added measured values for 960 GByte density and updated feature icons.	Doc. req. no. 2641
11-Jan-2019	1.12	Updated m.2 connector drawing (figure 4).	Doc. req. no. 2700
23-Jan-2019	1.13	Added new firmware part numbers and updated sections to meet standard data sheet review criteria.	Doc. req. no. 2741

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